

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3618139

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HEUI GYUN AHN	11/16/2015
SANG WOOK AHN	11/09/2015
YONG WOON LEE	11/11/2015
HUY CHAN JUNG	11/09/2015
SUNG CHUN JUN	11/09/2015
RECEIVING PARTY DATA	
Name:	SILICONFILE TECHNOLOGIES INC.
Street Address:	20F, 42, HWANGSAEWUL-RO 360BEON-GIL
Internal Address:	BUNDANG-GU SEONGNAM-SI
City:	GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14891629
CORRESPONDENCE DATA	
Fax Number:	(571)327-5452
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	571-327-5450
Email:	ipntlaw@ipntlaw.com
Correspondent Name:	IP & T GROUP LLP
Address Line 1:	8230 LEESBURG PIKE SUITE 650
Address Line 4:	VIENNA, VIRGINIA 22182
ATTORNEY DOCKET NUMBER:	P15P0053/US
NAME OF SUBMITTER:	MYUNG SOO KIM
SIGNATURE:	/Myung Soo KIM/
DATE SIGNED:	11/16/2015
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 5	

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**ASSIGNMENT OF AND DECLARATION FOR APPLICATION
FOR UNITED STATES LETTERS PATENT**

WHEREAS AEIN, Heul Gyun

hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

SEMICONDUCTOR DEVICE HAVING IMPROVED HEAT-DISSIPATION CHARACTERISTICS

said application being attached hereto;

said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____, and was amended on _____ (if applicable);

the specification of which was filed under the Patent Cooperation Treaty on May 9, 2014, Serial No. PCT/KR2014/004180, the United States of America being designated.

AND WHEREAS SILICONFILE TECHNOLOGIES INC.

hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

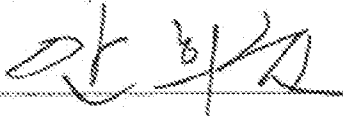
AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (INVENTOR):

Signature:  Date: 2015. 11. 16

Printed or Typed Name: AEIN, Heul Gyun

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

Attorney Docket No.: _____

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS AHN, Sang Wook, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to SEMICONDUCTOR DEVICE HAVING IMPROVED HEAT-DISSIPATION CHARACTERISTICS

[] said application being attached hereto;
[] said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____ and was amended on _____ (if applicable);
[X] the specification of which was filed under the Patent Cooperation Treaty on May 9, 2014 Serial No. PCT/KR2014/004180, the United States of America being designated.

AND WHEREAS SILICONFILE TECHNOLOGIES INC. hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (INVENTOR):

Signature: _____ Date: 2015/11/19

Printed or Typed Name: AHN, Sang Wook

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

Attorney Docket No.:

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS LEE, Yong Woon, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to SEMICONDUCTOR DEVICE HAVING IMPROVED HEAT DISSIPATION CHARACTERISTICS

[] said application being attached hereto;
[] said application having been filed in the United States Patent and Trademark Office on ... as Application Serial No. ... and was amended on ... (if applicable);
[X] the specification of which was filed under the Patent Cooperation Treaty on May 9, 2014, Serial No. PCT/KR2014/004180, the United States of America being designated.

AND WHEREAS SILICONILE TECHNOLOGIES INC. hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof.

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

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AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (INVENTOR):

Signature: [Handwritten Signature] Date: November 11, 2015

Printed or Typed Name: LEE, Yong Woon

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

Attorney Docket No.: _____

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS JUNG, Huy Chan

hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to SEMICONDUCTOR DEVICE HAVING IMPROVED HEAT-DISSIPATION CHARACTERISTICS

[] said application being attached hereto;
[] said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____, and was amended on _____ (if applicable);
[X] the specification of which was filed under the Patent Cooperation Treaty on May 9, 2014, Serial No. PCT/KR2014/004180, the United States of America being designated.

AND WHEREAS SILICONFILE TECHNOLOGIES INC. hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (INVENTOR):

Signature: 조세웅 Date: 2015.11.9

Printed or Typed Name: JUNG, Huy Chan

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

Attorney Docket No.: _____

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS JUN, Sung Chun

hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

SEMICONDUCTOR DEVICE HAVING IMPROVED HEAT-DISSIPATION CHARACTERISTICS

[] said application being attached hereto;

[] said application having been filed in the United States Patent and Trademark Office on

_____, as Application Serial No. _____, and was amended on _____ (if applicable);

[X] the specification of which was filed under the Patent Cooperation Treaty on May 9, 2014

Serial No. PCT/KR2014/004180, the United States of America being designated.

AND WHEREAS SILICONFILE TECHNOLOGIES INC.

hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (INVENTOR):

Signature: Sung Chun Jun Date: 2015. 11. 09

Printed or Typed Name: JUN, Sung Chun